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TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC273F, TC74VHC273FK

Octal D-Type Flip-Flop with Clear

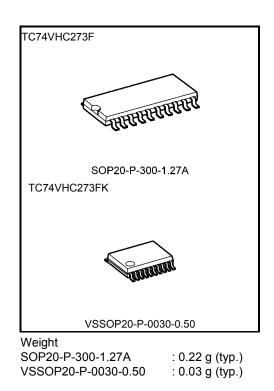
The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C^2 MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the $\overline{\mathrm{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

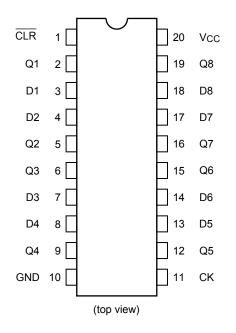


Features

- High speed: fmax = 165 MHz (typ.) at VCC = 5 V
- Low power dissipation: ICC = 4 μ A (max) at Ta = 25°C
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: tpLH ≃ tpHL
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS273

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Pin Assignment



IEC Logic Symbol

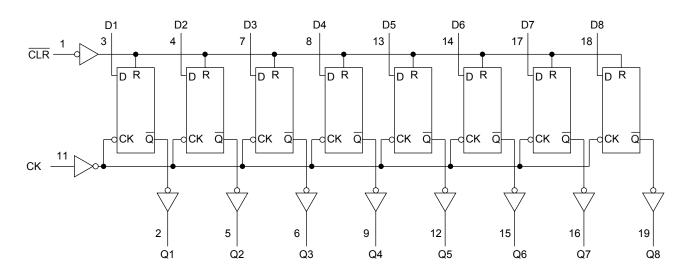
| CLR (1) CK (11) | R > C1 | |
|---|-----------|--|
| $\begin{array}{c} D1 & \underline{(3)} \\ D2 & \underline{(4)} \\ D3 & \underline{(7)} \\ D4 & \underline{(8)} \\ D5 & \underline{(13)} \\ D6 & \underline{(14)} \\ D7 & \underline{(17)} \\ D8 & \underline{(18)} \end{array}$ | 1D | (2) Q1 (5) Q2 (6) Q3 (9) Q4 (12) Q5 (15) Q6 (16) Q7 (19) Q8 |

Truth Table

| | Inputs | | Output | Function |
|-----|--------|----|----------------|-----------|
| CLR | D | СК | Q | Function |
| L | Х | Х | L | Clear |
| Н | L | | L | — |
| Н | Н | | Н | _ |
| Н | Х | | Q _n | No Change |

X: Don't care

System Diagram



Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|-------------------------------|------|
| Supply voltage range | Vcc | -0.5 to 7.0 | V |
| DC input voltage | VIN | -0.5 to 7.0 | V |
| DC output voltage | Vout | -0.5 to V _{CC} + 0.5 | V |
| Input diode current | Ік | -20 | mA |
| Output diode current | Іок | ±20 | mA |
| DC output current | Ιουτ | ±25 | mA |
| DC V _{CC} /ground current | lcc | ±75 | mA |
| Power dissipation | PD | 180 | mW |
| Storage temperature | T _{stg} | -65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|--------------------------|--------|--|------|
| Supply voltage | Vcc | 2.0 to 5.5 | V |
| Input voltage | VIN | 0 to 5.5 | V |
| Output voltage | Vout | 0 to V _{CC} | V |
| Operating temperature | Topr | -40 to 85 | °C |
| Input rise and fall time | dt/dv | 0 to 100 (V _{CC} = 3.3 \pm 0.3 V) 0 to 20 (V _{CC} = 5 \pm 0.5 V) | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

| Characteristics Symbol | | Test Condition | | ٦ | Ta = 25°C | | | Ta = -40 to 85°C | | |
|------------------------------|-------------------|--------------------------------|--|-------------------|----------------------------------|-------------------|----------------------------------|----------------------------------|----------------------------------|----|
| | | | Vcc | | Min | Тур. | Max | Min | Max | |
| High-level input voltage | VIH | _ | | 2.0 3.0 to 5.5 | 1.50 V _{CC} × 0.7 | | _ | 1.50 V _{CC} × 0.7 | | V |
| Low-level input voltage | VIL | — | | 2.0 3.0 to 5.5 | | | 0.50 V _{CC} × 0.3 | | 0.50 V _{CC} × 0.3 | V |
| High-level output voltage | -level output VIN | VIN = VIH or VIL | I _{OH} = -50 μA | 2.0 3.0 4.5 | 1.9 2.9 4.4 | 2.0 3.0 4.5 | | 1.9 2.9 4.4 | | V |
| Voltage | | | $I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$ | 3.0 4.5 | 2.58 3.94 | _ | _ | 2.48 3.80 | _ | |
| Low-level output voltage | Vol | VIN = VIH or VIL | I _{OL} = 50 μA | 2.0 3.0 4.5 | | 0.0 0.0 0.0 | 0.1 0.1 0.1 | | 0.1 0.1 0.1 | V |
| Voltage | | | l _{OL} = 4 mA l _{OL} = 8 mA | 3.0 4.5 | | | 0.36 0.36 | | 0.44 0.44 | |
| Input leakage current | l _{IN} | V _{IN} = 5.5 V or GND | | 0 to 5.5 | _ | | ±0.1 | _ | ±1.0 | μΑ |
| Quiescent supply current | ICC | $V_{IN} = V_{CC}$ or | GND | 5.5 | | | 4.0 | _ | 40.0 | μA |

Timing Requirements (input: tr = tf = 3 ns)

| Characteristics | Symbol | Test Condition | est Condition | | Ta = 25°C | | Unit |
|---|------------------|----------------|---|------|------------|------------|------|
| | | | V _{CC} (V) | Тур. | Limit | Limit | |
| Minimum pulse width (CK) | tw (L) tw (H) | — | $\begin{array}{c} 3.3\pm0.3\\ 5.0\pm0.5\end{array}$ | | 5.5 5.0 | 6.5 5.0 | ns |
| Minimum pulse width (\overline{CLR}) | tw (L) | — | $\begin{array}{c} 3.3\pm0.3\\ 5.0\pm0.5\end{array}$ | | 5.0 5.0 | 6.0 5.0 | ns |
| Minimum set-up time | ts | _ | $\begin{array}{c} 3.3\pm0.3\\ 5.0\pm0.5\end{array}$ | | 5.5 4.5 | 6.5 4.5 | ns |
| Minimum hold time | t _h | — | $\begin{array}{c} 3.3\pm0.3\\ 5.0\pm0.5\end{array}$ | | 1.0 1.0 | 1.0 1.0 | ns |
| Minimum removal time (\overline{CLR}) | t _{rem} | _ | $\begin{array}{c} 3.3\pm0.3\\ 5.0\pm0.5\end{array}$ | | 2.5 2.0 | 2.5 2.0 | ns |

AC Characteristics (input: tr = tf = 3 ns)

| Characteristics | Symbol | | Test Condition | | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | | | | | | | | |
|-------------------------------|-------------------|----------|-------------------------------|---------------------|-----------|------|------|---------------------|------|------|--|-------------|----|----|-----|---|----|---|
| | | | V _{CC} (V) | C _L (pF) | Min | Тур. | Max | Min | Max | | | | | | | | | |
| | | | 3.3 ± 0.3 | 15 | | 8.7 | 13.6 | 1.0 | 16.0 | | | | | | | | | |
| Propagation delay time | tpLH | | 3.3 ± 0.3 | 50 | | 11.2 | 17.1 | 1.0 | 19.5 | | | | | | | | | |
| (CK-Q) | tpHL | _ | 5.0 ± 0.5 | 15 | | 5.8 | 9.0 | 1.0 | 10.5 | ns | | | | | | | | |
| | | | 5.0 ± 0.5 | 50 | | 7.3 | 11.0 | 1.0 | 12.5 | | | | | | | | | |
| Propagation delay time t. | | tpHL — | 3.3 ± 0.3 | 15 | _ | 8.9 | 13.6 | 1.0 | 16.0 | ns | | | | | | | | |
| | 4 | | | 50 | _ | 11.4 | 17.1 | 1.0 | 19.5 | | | | | | | | | |
| (CLR -Q) | чрн∟ | | 5.0 ± 0.5 | 15 | _ | 5.2 | 8.5 | 1.0 | 10.0 | | | | | | | | | |
| | | | | 50 | _ | 6.7 | 10.5 | 1.0 | 12.0 | | | | | | | | | |
| | | _ | 3.3 ± 0.3 | 15 | 75 | 120 | _ | 65 | _ | | | | | | | | | |
| Maximum clock | fmax | | 5.5 ± 0.5 | 50 | 50 | 75 | — | 45 | — | MHz | | | | | | | | |
| frequency | Imax | | 50.05 | 15 | 120 | 165 | _ | 100 | _ | | | | | | | | | |
| | | | | | | | | | | | | 5.0 ± 0.5 | 50 | 80 | 110 | _ | 70 | _ |
| | t _{osLH} | (Noto 1) | $\textbf{3.3}\pm\textbf{0.3}$ | 50 | _ | _ | 1.5 | — | 1.5 | ns | | | | | | | | |
| Output to output skew | t _{osHL} | (Note 1) | 5.0 ± 0.5 | 50 | _ | | 1.0 | _ | 1.0 | 115 | | | | | | | | |
| Input capacitance | CIN | | _ | | _ | 4 | 10 | | 10 | pF | | | | | | | | |
| Power dissipation capacitance | C _{PD} | | | (Note 2) | _ | 31 | _ | _ | _ | pF | | | | | | | | |

Note 1: Parameter guaranteed by design.

tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $ICC (opr) = CPD \cdot VCC \cdot fIN + ICC/8 (per bit)$

And the total CPD when n pcs.of flip flop operate can be gained by the following equation:

CPD (total) = 22 + 9·n

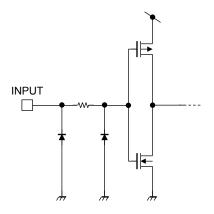
Noise Characteristics (input: tr = tf = 3 ns)

| Oh ann ata riation | Currente al | Test Condition | | Ta = 25°C | | 1.1 |
|--|-------------|----------------|---------------------|-----------|------|------|
| Characteristics | Symbol | | V _{CC} (V) | Тур. | Max | Unit |
| Quiet output maximum dynamic VOL | Volp | CL = 50 pF | 5.0 | 0.5 | 0.8 | V |
| Quiet output minimum dynamic VOL | Volv | CL = 50 pF | 5.0 | -0.5 | -0.8 | V |
| Minimum high level dynamic input voltage | Vihd | CL = 50 pF | 5.0 | _ | 3.5 | V |
| Maximum low level dynamic input voltage | VILD | CL = 50 pF | 5.0 | _ | 1.5 | V |

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Input Equivalent Circuit

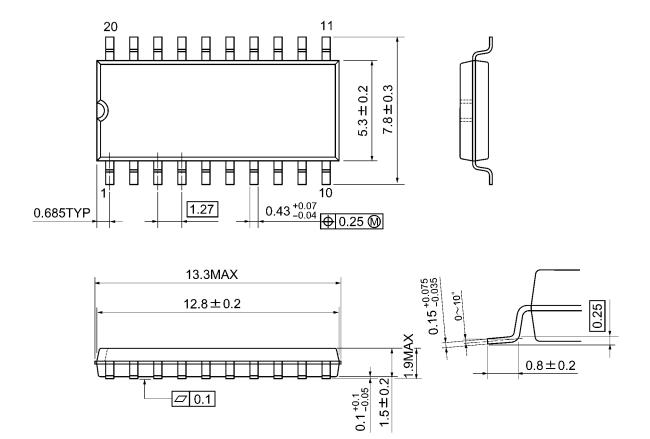




Package Dimensions

SOP20-P-300-1.27A

Unit: mm



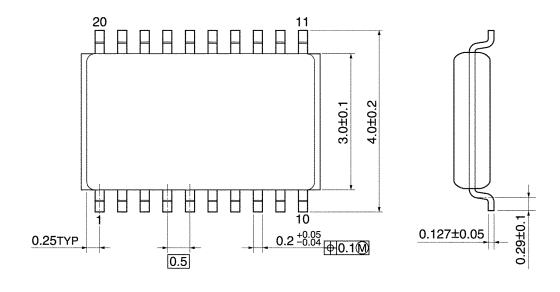
Weight: 0.22 g (typ.)

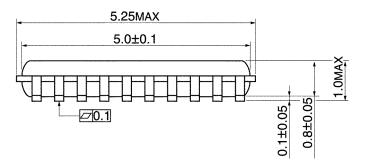


Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm





Weight: 0.03 g (typ.)

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